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PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Heiko Knoll	06/06/2012

RECEIVING PARTY DATA

Name:	IXYS Semiconductor GmbH	
Street Address:	Edisonstrasse 15	
City:	Lampertheim	
State/Country:	GERMANY	
Postal Code:	68623	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13482685

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	73385-840167 (019900US)
NAME OF SUBMITTER:	Margaret Stephan

Total Attachments: 2

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> PATENT REEL: 028777 FRAME: 0661

OF \$40.00 13482685

Attorney Docket No. 73385-840167 (019900US)
Client Ref. No. IX10002US

ASSIGNMENT (Patent Application)

I, the undersigned, have invented certain inventions and improvements disclosed in a utility (provisional or non-provisional) or design patent application entitled

"METHOD OF JOINING METAL-CERAMIC SUBSTRATES TO METAL BODIES"

filed with the U.S. Patent & Trademark Office on May 29, 2012, and assigned Serial No. 13/482,685.

For one dollar (\$1.00) and other good and valuable consideration, the receipt and sufficiency of which I acknowledge, we:

- 1. Agree to assign, transfer, convey, and sell, hereby assign, transfer, convey, and sell and have assigned, transferred, conveyed, and sold to IXYS Semiconductor GmbH, a corporation of Germany having a principal place of business at Edisonstrasse 15, Lampertheim, 68623, Germany ("Assignee"), the entire right, title, and interest in and to:
 - (a) all intellectual property (including, without limitation, any innovation, information, invention, discovery, product, process, work or design) disclosed, embodied, shown, or claimed in the above-referenced patent application, implicitly or explicitly;
 - (b) the above-referenced patent application, the right to claim priority to the above-referenced patent application, all applications based in whole or in part upon the above-referenced patent application, including, without limitation, all applications that are a provisional, non-provisional, design, divisional, continuation, continuation-in-part, registration, utility model, industrial design, reissue, renewal, substitute, extension, reexamination, post-grant review, inter partes review, supplemental examination or non-U.S. patent application or application for other rights based in whole or in part on the above-referenced patent application;
 - (c) all patents (including, without limitation, all U.S. and non-U.S. patents, registrations, utility models, industrial designs, design patents, counterparts, continuations, continuations-in-part, divisionals, reissues, renewals, substitutes, extensions, reexaminations, post-grant reviews, inter partes reviews and supplemental examinations) that are granted or issued upon, or that claim priority to, any and all applications described in (b) of

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ASSIGNMENT Method of Joining Metal-Ceramic Substrates to Metal Bodies Page 2 of 2

this paragraph or that disclose or claim intellectual property described in (a) of this paragraph, in whole or in part; and

- (d) all claims for damages by reason of past infringement of any rights under the applications or patents described in (a), (b) or (c) of this paragraph (including provisional rights to reasonable royalties pursuant to 35 U.S.C. §154(d)) and the right to sue for and collect such damages and royalties for Assignee's own use.
- 2. Authorize and request the U.S. Patent and Trademark Office or any other U.S. or non-U.S. agency to issue to the Assignee any and all patent(s), or other rights or documents, resulting from the intellectual property, patent application(s) and patents described in paragraph 1 of this Assignment.
- 3. Agree to sign all papers and documents, including without limitation, applications, declarations, oaths and petitions, and, at the Assignee's expense, perform any other acts that are necessary in connection with prosecution of patent application(s) or intellectual property described in paragraph 1 of this Assignment and the enforcement of patent(s) or other rights resulting from such patent application(s) or intellectual property.
- 4. Agree that the terms, covenants, and conditions of this Assignment shall inure to the benefit of the Assignee, its successors, assigns and other legal representative, and shall be binding upon me, as well as my heirs, legal representatives, and assigns.
- 5. Promise and affirm that I have not entered, and will not enter, into any assignment, contract, or understanding that conflicts with this Assignment.
- 6. Authorize Kilpatrick Townsend & Stockton to insert above the application number and filing date of the above-described patent application when known.

Signed on the date indicated beside my signature.

06/06/2012 Date: Heiko Knoll

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RECORDED: 08/13/2012

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